

SA data sheet SA-1064-14-28ps-x, λ = 1064 nm

Laser wavelength $\lambda = 1000 \text{ nm} \dots 1100 \text{ nm}$

Absorptance $A_0 = 14 \%$ Transmittance T = 85 %Modulation depth $\Delta T = 3.4 \%$

Saturation fluence $\Phi_{\text{sat}} = 300 \ \mu\text{J/cm}^2$ Damage threshold P/A = 200 MW/cm²

Relaxation time constant $\tau \sim 28 \text{ ps}$

Chip area 5.0 mm x 5.0 mm; other dimensions on request

Chip thickness 625 µm; semi-insulating GaAs

Front side protection AR coating for 1064 nm

Back side coating the SA back side is polished and antireflection coated for 1064 nm

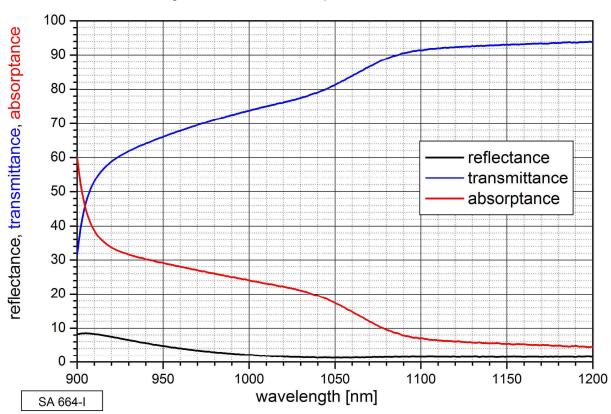
Mounting of SA-1064-14-28ps-x denotes the type of mounting as follows:

x = 0 unmounted

x = 12.7 g glued on a copper heat sink with 12.7 mm Ø and 4 mm Ø center hole glued on a copper heat sink with 25.4 mm Ø and 4 mm Ø center hole x = FC a back-thinned SA chip with 100 μm thickness is mounted inside a 1 m

monomode fiber cable

low intensity reflectance, absorptance and transmittance





Relaxation time τ measurement

